# **Course Number and Name**

BPH201 & Engineering Physics -II

## **Credits and Contact Hours**

3 & 45

### **Course Coordinator's Name**

Mrs.Lyola

# **Text Books and References**

#### Text Book:

- 1. Jayaraman D Engineering Physics II. Global Publishing House, 2014.
- 2. Palanisamy P.K. Materials Science. SCITECH Publishers, 2011.
- 3. Senthilkumar G. Engineering Physics II. VRB Publishers, 2011.

#### **References:**

- 1. Arumugam M., Materials Science. Anuradha publishers, 2010
- 2. Pillai S.O., Solid State Physics. New Age International(P) Ltd., publishers, 2009
- 3. Marikani A. Engineering Physics. PHI Learning Pvt., India, 2009
- 4. http://ocw.mit.edu/courses/find-by-topic
- 5. http://nptel.ac.in/course.php?disciplineId=122
- 6. https://en.wikipedia.org/wiki/Engineering\_physics

# Course Description

- a) To expose the students to multiple areas of science of engineering materials which have direct relevance to different Engineering applications
- b) To understand the concepts and applications of conducting, Semiconducting, magnetic & dielectric materials as well as their optical properties.

<u> </u>	<del>,                                      </del>						
Prerequisites	Co-requisites						
Physics-I	Nil						
required, elective, or selected elective (as per Table 5-1)							
Required							

### Course Outcomes (COs)

- CO1: Understand about properties and advancements of conducting materials.
- CO2: Understand the principle and properties semiconducting materials.
- CO3: Acquire Knowledge on Magnetic and dielectric Materials.
- CO4: To Know about the creation of new materials with novel properties
- CO5: To Understand the impact of modern materials in technical uses.
- CO6: Learn new engineering materials and its characteristics

# Student Outcomes (SOs) from Criterion 3 covered by this Course

COs/SOs	a	b	c	d	e	f	g	h	i	j	k	1
CO1	Н											
CO2		L	Н		M							
CO3		M		Н								
CO4	Н		M	L								
CO5		L	L									
CO6	Н											

### List of Topics Covered

## UNIT I CONDUCTING MATERIALS

Conductors – classical free electron theory of metals – Electrical and thermal conductivity –

Wiedemann – Franz law – Lorentz number – Draw backs of classical theory – Quantum theory –

Fermi distribution function – Effect of temperature on Fermi Function – Density of energy states – carrier concentration in metals.

### UNIT II SEMICONDUCTING MATERIALS

9

Intrinsic semiconductor – carrier concentration derivation Fermi level – Variation of Fermi level with temperature – electrical conductivity – band gap determination – compound semiconductors -direct and indirect band gap- derivation of carrier concentration in n-type and p-type semiconductor – variation of Fermi level with temperature and impurity concentration — Hall effect –Determination of Hall coefficient – Applications.

### UNIT III MAGNETIC AND SUPERCONDUCTING MATERIALS 9

Origin of magnetic moment – Bohr magneton – comparison of Dia, Para and Ferro magnetism – Domain theory – Hysteresis – soft and hard magnetic materials – antiferromagnetic materials – Ferrites and its applications Superconductivity: properties – Type I and Type II superconductors – BCS theory of superconductivity(Qualitative) - High Tc superconductors – Applications of Superconductors – SQUID, cryotron, magnetic levitation.

## UNIT IV DIELECTRIC MATERIALS

9

Electrical susceptibility – dielectric constant – electronic, ionic, orientation and space charge polarization – frequency and temperature dependence of polarization – internal field – Claussius – Mosotti relation (derivation) – dielectric loss – dielectric breakdown – uses of dielectric materials (capacitor and transformer) – ferroelectricity and applications.

### UNIT V ADVANCED ENGINEERING MATERIALS 9

Metallic glasses: preparation, properties and applications. Shape memory alloys (SMA): Characteristics, properties of NiTi alloy, application, Nanomaterials—Preparation -pulsed laser deposition – chemical vapour deposition – Applications – NLO materials –Birefringence- optical Kerr effect – Classification of Biomaterials and its applications.